TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

SSM3K44MFV

High Speed Switching Applications Analog Switch Applications

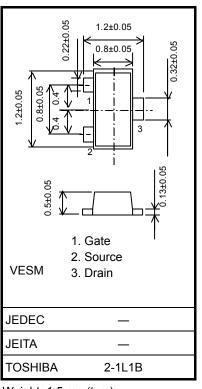
- Compact package suitable for high-density mounting
- Low ON-resistance : $R_{DS(ON)} = 4.0 \Omega \text{ (max)} (@V_{GS} = 4 \text{ V})$: $R_{DS(ON)} = 7.0 \Omega \text{ (max)} (@V_{GS} = 2.5 \text{ V})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	30	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC	I _D	100	mA	
	Pulse	I _{DP}	200		
Drain power dissipation (Ta = 25° C)		P _D (Note 1)	150	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature		T _{stg}	-55 to 150	°C	

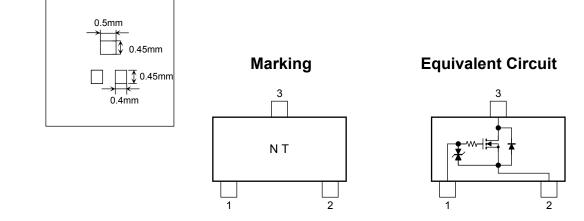
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



Weight: 1.5 mg (typ.)

Note 1: Total rating, mounted on FR4 board (25.4 mm \times 25.4 mm \times 1.6 mm)



Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Start of commercial production 2009-12

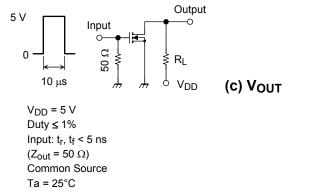
Electrical Characteristics (Ta = 25°C)

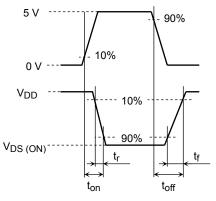
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS}=\pm 14~V,~V_{DS}=0~V$	—	_	±1	μA
Drain-source brea	akdown voltage	V (BR) DSS	$I_D = 0.1 \text{ mA}, V_{GS} = 0 \text{ V}$	30	_	_	V
Drain cut-off curre	ent	I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		_	1	μA
Gate threshold vo	oltage	V _{th}	$V_{DS} = 3 \text{ V}, \text{ I}_{D} = 0.1 \text{ mA}$	0.8	_	1.5	V
Forward transfer	admittance	Y _{fs}	$V_{DS} = 3 \text{ V}, \text{ I}_{D} = 10 \text{ mA}$	25	_		mS
Drain-Source on-resistance		R _{DS (ON)}	$I_D = 10 \text{ mA}, V_{GS} = 4 \text{ V}$		2.2	4.0	Ω
			$I_D = 10 \text{ mA}, V_{GS} = 2.5 \text{ V}$		4.0	7.0	
Input capacitance		C _{iss}	V _{DS} = 3 V, V _{GS} = 0 V, f = 1 MHz		8.5		pF
Reverse transfer capacitance		C _{rss}			5.3	_	
Output capacitance		C _{oss}	1		9.4		
Switching time	Turn-on time	t _{on}	V _{DD} = 5 V, I _D = 10 mA, V _{GS} = 0 to 5 V		50	—	ns
	Turn-off time	t _{off}			200	—	

Switching Time Test Circuit

(a) Test circuit

(b) V_{IN}



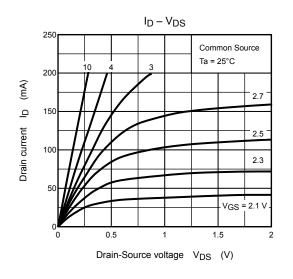


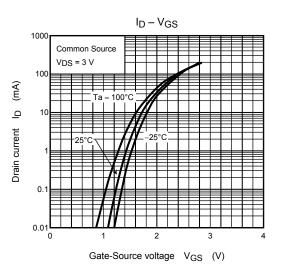
Precaution

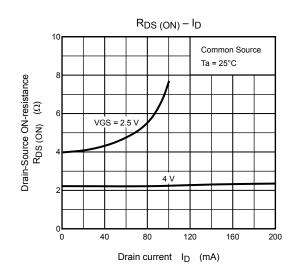
 V_{th} can be expressed as the voltage between gate and source when the low operating current value is I_D = 100 μ A for this product. For normal switching operation, V_{GS (on)} requires a higher voltage than V_{th} and V_{GS (off)} requires a lower voltage than V_{th}.

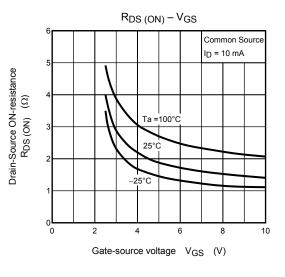
(The relationship can be established as follows: V_{GS (off)} < V_{th} < V_{GS (on)}) Please take this into consideration when using the device.

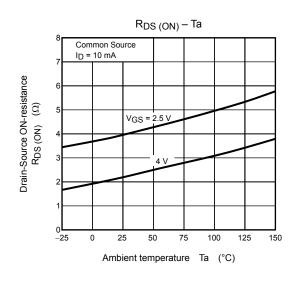
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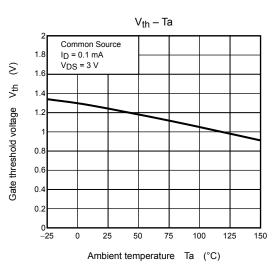




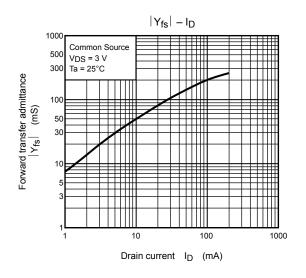


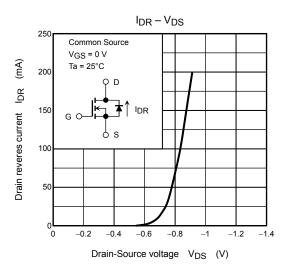


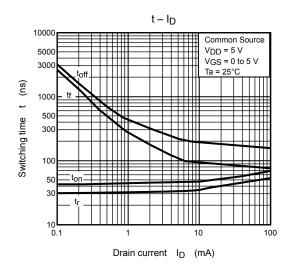


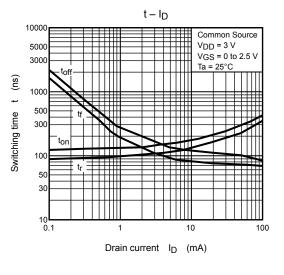


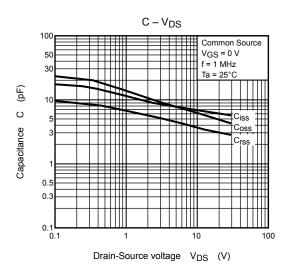
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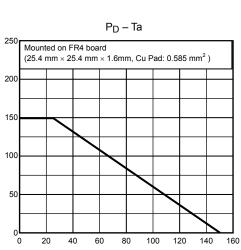












(MM)

 $^{\mathsf{D}}_{\mathsf{D}}$

Drain power dissipation

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